

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Teruyuki OHNISHI	09/07/2011
Shinichi ISOBE	09/07/2011
Kohtaro SHIINO	09/12/2011
Toru TAKAHASHI	09/07/2011
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13283027
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ASSIGNMENT

U.S. Rights - Sole or Joint

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For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto

name and address of assignee
HITACHI AUTOMOTIVE SYSTEMS, LTD.
2520, Takaba, Hitachinaka-shi,
Ibaraki 312-8503 Japan

(hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to his invention relating to

title of invention
CONNECTING STRUCTURE AND PRODUCTION METHOD

as set forth in his/her United States Patent Application

check one
(X) executed concurrently herewith
() executed on _____
(X) Serial No. 13/283,027 Filed October 27, 2011

in and to said United States Patent Application including any and all divisions or continuations and Convention applications based in whole or in part on said invention or upon said application, including the right to make applications for Letters Patents throughout the world in respect to the invention and to claim priority under the International Convention for the Protection of Industrial Property, and in and to any and all Letters Patent of any country which may issue on any such application or for said invention, including any and all reissues, reexaminations, or extensions, to be held and enjoyed by said ASSIGNEE, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not be made;

Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

Each of the undersigned warrants and covenants that he/she has the full and unencumbered right to sell and assign the interests herein sold and assigned and that he/she has not executed and will not execute any document or instrument in conflict herewith;

Each of the undersigned further covenants and agrees that at any time upon request of said ASSIGNEE, its successors, legal representatives or assigns he/she will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him/her relating to said invention or patent application and that he/she will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues, reexaminations, or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention;

Each of the undersigned hereby grants the firm of **Foley & Lardner LLP** the power to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

names and signatures of inventors
Teruyuki Ohnishi date 09/07/2011 Name: Teruyuki Ohnishi
Shinichi Isobe date 09/07/2011 Name: Shinichi Isobe
Kohtaro Shiino date 09/12/2011 Name: Kohtaro Shiino
Toru Takahashi date 09/07/2011 Name: Toru Takahashi

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RECORDED: 10/27/2011

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